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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO	
10/712,108	11/14/2003	Cheng-Tsung Yu	0941-0752P	8218	
2292	7590 09/07/2006		EXAM	EXAMINER	
	EWART KOLASCH	MOORE, I	MOORE, KARLA A		
PO BOX 747 FALLS CHURCH, VA 22040-0747			ART UNIT	PAPER NUMBER	
	•		1763		

DATE MAILED: 09/07/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary		Application No.	Applicant(s)			
		10/712,108	YU ET AL.			
		Examiner	Art Unit			
		Karla Moore	1763			
Period fo	The MAILING DATE of this communication app or Reply	ears on the cover sheet with the c	orrespondence address			
WHIC - Exter after - If NO - Failu Any r	ORTENED STATUTORY PERIOD FOR REPLY CHEVER IS LONGER, FROM THE MAILING DATE in a solid part of the provisions of 37 CFR 1.13 SIX (6) MONTHS from the mailing date of this communication. The period for reply is specified above, the maximum statutory period were to reply within the set or extended period for reply will, by statute, reply received by the Office later than three months after the mailing and patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tin vill apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE	N. nely filed the mailing date of this communication. ED (35 U.S.C. § 133).			
Status						
1)🛛	Responsive to communication(s) filed on 19 Ju	<u>ıne 2006</u> .	?			
2a)⊠	This action is FINAL . 2b) ☐ This	action is non-final.	·			
3)□	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is					
	closed in accordance with the practice under E	x parte Quayle, 1935 C.D. 11, 49	53 O.G. 213.			
Dispositi	on of Claims					
5)□ 6)⊠ 7)□	Claim(s) 1,2,4-9,11-18 and 21 is/are pending ir 4a) Of the above claim(s) is/are withdraw Claim(s) is/are allowed. Claim(s) 1,2,4-9,11-18 and 21 is/are rejected. Claim(s) is/are objected to. Claim(s) are subject to restriction and/or	vn from consideration.				
Applicati	on Papers					
9)□ :	The specification is objected to by the Examine	r.				
10)⊠ The drawing(s) filed on <u>14 November 2003</u> is/are: a)⊠ accepted or b)□ objected to by the Examiner.						
	Applicant may not request that any objection to the	drawing(s) be held in abeyance. See	e 37 CFR 1.85(a).			
. —	Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).					
11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.						
Priority u	ınder 35 U.S.C. § 119					
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No. 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 						
Attachment	t(s)					
2) Notice 3) Inform	e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (PTO-948) nation Disclosure Statement(s) (PTO/SB/08) r No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal P 6) Other:	ate			

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DETAILED ACTION

Claim Rejections - 35 USC § 112

- 1. The following is a quotation of the second paragraph of 35 U.S.C. 112:
 - The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.
- 2. Claim 13 is rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention. The claim recites the limitation "the other portion". There is insufficient antecedent basis for this limitation in the claim.

Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).
- 5. Claims 1-2, 4-7 and 11-16 are rejected under 35 U.S.C. 103(a) as being unpatentable over U.S. Patent No. 5,411,624 to Hirano et al. in view of U.S. Patent No. 4,793,975 to Drage.
- 6. Hirano et al. disclose a pedestal supporting a substrate in a plasma chamber as claimed in Figure 1 substantially as claimed and comprising: an insulating base (16; column 4, row 32) comprising a recess; a conductive layer (12, which is used as an electrode and therefore must be conductive; column

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4, rows 17-20 and column 5, rows 8-14) comprising a bottom portion with a width accommodated in the recess and an upper portion with an upper width not accommodated in the recess; and a ceramic cover (22 and 24; column 5, rows 45-52) at least partially covering the conductive layer, the conductive layer being covered when the pedestal supports a substrate.

- 7. Regarding the height of the cover ring, Hirano et al. teach that the height of the ceramic cover can be adjusted to achieve a desired etching rate. It would have been obvious to one of ordinary skill in the art to adjust the height as needed (including a height where the cover is lower than a substrate) if desired. See column 7, rows 19-49 of Hirano et al.
- 8. However, Hirano et al. fail to teach the ceramic cover comprises aluminum oxide.
- 9. Drage teaches providing an aluminum oxide ceramic cover for a conductive layer of a substrate support pedestal for the purpose of improving uniformity and etch rate in cooperation with other elements of a plasma reactor (column 1, row 60 through column 2, row 2 and column 2, rows 46-62). It is taught that the material for the cover can be chosen depending on the function to be performed.
- 10. It would have been obvious to one of ordinary skill in the art at the time the Applicant's invention was made to have provided a cover comprising aluminum oxide in Hirano et al. in order to improve uniformity and etch rate in cooperation with other elements of a plasma reactor as taught by Drage.
- 11. With respect to claim 2, the upper width is less than the bottom width and a diameter of the substrate (Figures 1 and 2).
- 12. With respect to claim 4, the ceramic cover further overlies the insulating base (Figure 1).
- 13. With respect to claim 5, the ceramic cover further comprises an opening exposing the conductive layer (see Figure 2).
- 14. With respect to claim 6, the ceramic cover overlies the bottom portion of the conductive layer and further comprises a hollow portion (central portion) accommodating the upper portion of the conductive layer (see Figures 1 and 2).
- With respect to claim 7, the ceramic cover is ring shaped (column 5, rows 45-52).
- 16. With respect to claim 11, Hirano et al. further disclose in Figures 1 and 2, a pedestal supporting a substrate in a plasma chamber, comprising: an insulating base (16) having a recess; a ceramic cover (22 and 24) overlying the insulating base and partially veering the conductive layer; wherein the conductive

layer is covered when the pedestal supports a substrate and the conductive layer further comprises an upper portion protruding from the recess.

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- 17. With respect to claim 12, the upper portion is with a width less than the diameter of the substrate. Examiner notes that while the prior art discloses processing a substrate to be processed with a diameter greater than that of the upper portion, the courts have ruled that inclusion of material or article worked upon by a structure being claimed does not impart patentability to the claims. In re Young, 75 F.2d 966, 25 USPQ 69 (CCPA 1935) (as restated in In re Otto, 312 F.2d 937, 136 USPQ 458, 459 (CCPA 1963)).
- 18. With respect to claim 13, the width of the upper portion is less than the width of a lower portion of the conductive layer.
- 19. With respect to claim 14, the ceramic cover comprises a hollow (central) portion accommodating the upper portion of the conductive layer.
- 20. With respect to claim 15, the ceramic cover further comprises a hollow portion accommodating the upper portion of the conductive layer and exposing the upper portion of the conductive layer (Figures 1 and 2).
- 21. With respect to claim 16, the ceramic cover is ring shaped (column 5, rows 45-52).
- 22. Claims 8 and 17 are rejected under 35 U.S.C. 103(a) as being unpatentable over Hirano et al. and Drage as applied to claims 1-2, 4-7 and 11-16 above and further in view of Applicant's admitted prior art (AAPA).
- 23. Hirano et al. and Drage disclose a pedestal substantially as claimed and as described above.
- 24. However, Hirano et al. and Drage fail to teach the insulating base comprised of silicon dioxide.
- 25. Applicant's admitted prior art teaches that it is known to provide a base of a pedestal constructed of silicon oxide to take advantage of the material's insulative property (page 1).
- 26. It would have been obvious to one of ordinary skill in the art at the time the Applicant's invention was made to have provided the insulating base constructed of silicon oxide in Hirano et al. and Drage in order to take advantage of the material's insulative property as taught by AAPA.

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27. Claims 9 and 18 are rejected under 35 U.S.C. 103(a) as being unpatentable over Hirano et al. and Drage as applied to claims 1-2, 4-7 and 11-16 above and further in view of U.S. Patent Publication No. 2005/0098120 A1 to Maki.

- 28. Hirano et al. and Drage disclose the invention substantially as claimed and as described above.
- 29. However, Hirano et al. and Drage fail to teach the conductive layer as titanium. Maki teaches the use of titanium as a pedestal material for the purpose of forming a temperature controlling section with superior thermal conductivity, electric conductivity and formability (paragraph 46).
- 30. It would have been obvious to one of ordinary skill in the art at the time the Applicant's invention was made to have provided titanium as a construction material for the conductive layer in Hirano et al. and Drage in order to form a pedestal having a temperature controlling section with superior thermal conductivity, electrical conductivity and formability as taught by Maki.
- 31. Claims 20-22 are rejected under 35 U.S.C. 103(a) as being unpatentable over U.S. Patent No. 5,411,624 to Hirano et al. in view of Applicant's Admitted Prior Art, U.S. Patent Publication No. 2005/0098120 A1 to Maki and U.S. Patent No. 4,793,975 to Drage.
- 32. Hirano et al. disclose a pedestal supporting a substrate in a plasma chamber substantially as claimed in Figure 1 and comprising: an insulating base (16; column 4, row 32) comprising a recess; a conductive layer (12, which is used as an electrode and therefore must be conductive; column 4, rows 17-20 and column 5, rows 8-14) having a bottom portion embedded in the recess and an upper portion, narrower than the bottom portion and the substrate, protruding from the recess; and a ring-shaped ceramic cover (22 and 24; column 5, rows 45-52) having a hollow (central) portion accommodating the upper portion or the bottom portion of the conductive layer; wherein the conductive layer is covered when the pedestal supports the substrate.
- 22. Regarding the height of the cover ring, Hirano et al. teach that the height of the ceramic cover can be adjusted to achieve a desired etching rate. It would have been obvious to one of ordinary skill in the art to adjust the height as needed (including a height where the cover is lower than a substrate) if desired. See column 7, rows 19-49 of Hirano et al.

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33. However, Hirano et al. fail to teach the insulating base comprised of silicon dioxide.

34. Applicant's admitted prior art teaches that it is known to provide a base of a pedestal constructed

of silicon oxide to take advantage of the material's insulative property (page 1).

35. It would have been obvious to one of ordinary skill in the art at the time the Applicant's invention

was made to have provided the insulating base constructed of silicon oxide in Hirano et al. in order to

take advantage of the material's insulative property as taught by AAPA.

36. Hirano et al. and AAPA disclose the invention substantially as claimed and as described above.

37. However, Hirano et al. and AAPA fail to teach the conductive layer as titanium. Maki teaches the

use of titanium as a pedestal material for the purpose of forming a temperature controlling section with

superior thermal conductivity, electric conductivity and formability (paragraph 46).

38. It would have been obvious to one of ordinary skill in the art at the time the Applicant's invention

was made to have provided titanium as a construction material for the conductive layer in Hirano et al.

and AAPA in order to form a pedestal having a temperature controlling section with superior thermal

conductivity, electrical conductivity and formability as taught by Maki.

39. Hirano et al., AAPA and Maki disclose the invention substantially as claimed and as described

above.

40. However, Hirano et al., AAPA and Maki fail to teach the ceramic cover comprises aluminum

oxide.

41. Drage teaches providing an aluminum oxide ceramic cover for a conductive layer of a substrate

support pedestal for the purpose of improving uniformity and etch rate in cooperation with other elements

of a plasma reactor (column 1, row 60 through column 2, row 2 and column 2, rows 46-62). It is taught

that the material for the cover can be chosen depending on the function to be performed.

42. It would have been obvious to one of ordinary skill in the art at the time the Applicant's invention

was made to have provided a cover comprising aluminum oxide in Hirano et al., AAPA and Maki in order

to improve uniformity and etch rate in cooperation with other elements of a plasma reactor as taught by

Drage,

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43. With respect to claim 21, the ceramic cover further comprises a hollow portion accommodating the upper portion of the conductive layer and exposing *the upper* portion of the conductive layer (Figures 1 and 2).

Response to Arguments

- 44. Applicant's arguments filed 19 June 2006, with respect to the 112 rejection of claim 13, have been fully considered but they are not persuasive. Examiner maintains the position that the lack of antecedent basis in the claims renders the claim unclear and therefore the rejection is maintained. As the claim now reads it is not clear what width of what portion is to be compared to the width of the upper portion.
- Applicant's arguments with respect to the art rejections regarding the combination of Hirano et al. and Drage are not convincing, either. Hirano et al. teach that the height of the ceramic cover can be adjusted to achieve a desired etching rate. It would have been obvious to one of ordinary skill in the art to adjust the height as needed (including a height where the cover is lower than a substrate) if desired. Further, Hirano et al. teach that it is not imperative for the cover ring to be conductive. Like the height of the of the cover ring, the material of construction of the cover ring (including even insulating materials) can be chosen based on desired processing results. See column 7, rows 19-49 of Hirano et al.

Conclusion

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of

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the advisory action. In no event, however, will the statutory period for reply expire later than SIX

MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should

be directed to Karla Moore whose telephone number is 571.272.1440. The examiner can normally be

reached on Monday-Friday, 9:00 am-6:00 pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor,

Parviz Hassanzadeh can be reached on 571.272.1435. The fax phone number for the organization

where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application

Information Retrieval (PAIR) system. Status information for published applications may be obtained from

either Private PAIR or Public PAIR. Status information for unpublished applications is available through

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you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC)

at 866-217-9197 (toll-free).

Kada Moore

Prinary Examiner

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1 September 2006